



Suzhou LiShengDa Electronic Technology Co., Ltd

APPROVAL SHEET NO.: NQ-APS-042

LRLN Series

Metal Alloy Long Terminal

Low-Resistance Resistor

Product Specifications

Rev. A0

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Features

- Metal Alloy Long Terminal Low-Resistance Resistor
- Low thermal EMF
- Low TCR
- Low inductance

Applications

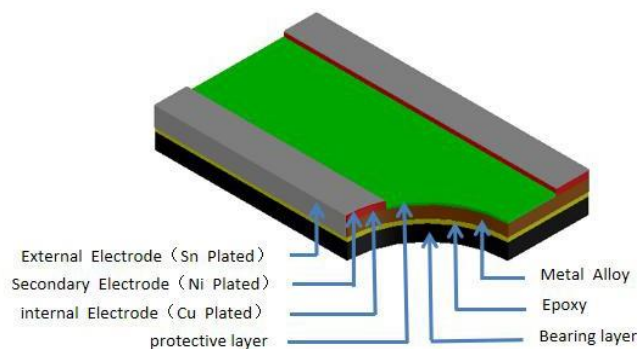
- Battery pack
- Inverter/Converter
- Consumer electronics
- Notebook

Part number

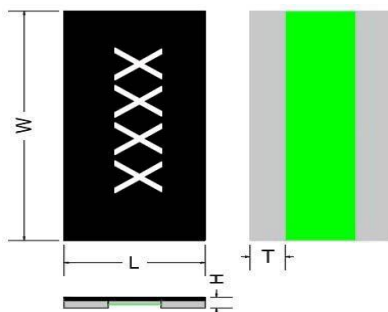
Explanation Of Part Numbers: LRLN06CFTR010A = LRLN series 0612 Size 1W 1% 5mΩ

<u>LRLN</u>	<u>06</u>	<u>C</u>	<u>F</u>	<u>T</u>	<u>R005</u>	<u>A</u>
Series	Dimension	Rated Power	Tolerance	Packaging	Resistance	Terminals
LRLN: Metal alloy long terminal Resistor	06: 0612 05: 0508	C: 1W	D:0.5% ;F:1% ;J:5%	T:Paper	R005=5mΩ	A: 2 terminal B: 4 terminal

Construction



Physical Dimensions (mm)



Unit : mm

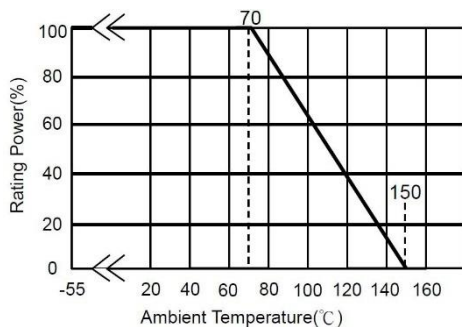
Size	R Value	L	W	H	T
0612	1mΩ	1.60±0.20	3.20±0.20	Max 0.40	0.40±0.15
0612	1.5mΩ~25 mΩ	1.60±0.20	3.20±0.20	Max 0.35	0.40±0.15
0508	1mΩ	1.26±0.20	2.06±0.20	Max 0.40	0.33±0.15
0508	1.5mΩ~10 mΩ	1.26±0.20	2.06±0.20	Max 0.35	0.33±0.15

Standard Electrical Specifications

Size	Power Rating at 70℃(W)	Resistance Range (mΩ)	TCR (ppm/℃)	Resistance Tolerance (%)	Rating Current	Operation Temperature Range
0612	1	1~2	±70	D:0.5% ;F:1% ;J:5%	(P/R) ^{1/2}	-55℃~+150℃
0612	1	3~25	±50			
0508	1	1~2	±100			
0508	1	3~10	±75			

* Note: P=Rating Power ; R=Resistance Value

Power Derating Curve



For resistors operated in ambient over 70℃, rated load (rated power) shall be derated in accordance with the above figure.

Rated Current

The rated Current is calculated by the following formula:

$$I = \sqrt{P/R}$$

I = Rating current (A)

P= Rating Power (W)

R= Resistance(Ω)

■ Marking Format :

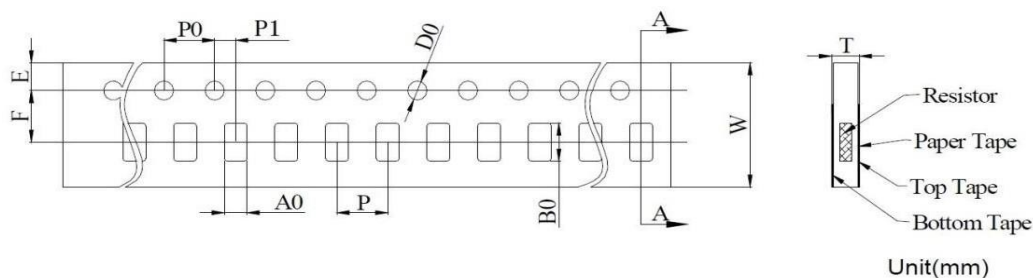
For 0612 Size is marked with four digit. We have two different ways of marking:

- “R” designates the decimal location in ohms, e.g. $1\text{m}\Omega$: R001; $10\text{m}\Omega$: R010;
- “m” designates the decimal location in milliohms, e.g. $0.5\text{m}\Omega$: 0m50; $5.5\text{m}\Omega$: 5m50;

For 0508 Size is marked with three digit. We have two different ways of marking:

- “R” designates the decimal location in ohms, e.g. $1\text{m}\Omega$: 001; $10\text{m}\Omega$: 010
- “m” designates the decimal location in milliohms, e.g. $0.5\text{m}\Omega$: 0m5; $1.5\text{m}\Omega$: 1m5

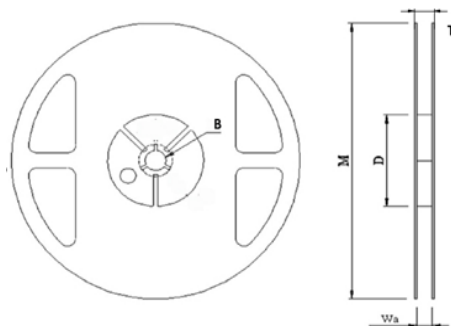
■ Taping specification



Size	0612	0508
A0	2.00 ± 0.20	1.66 ± 0.20
B0	3.60 ± 0.20	2.46 ± 0.20
E	1.75 ± 0.10	1.75 ± 0.10
F	3.50 ± 0.05	3.50 ± 0.05
W	8.00 ± 0.20	8.00 ± 0.20
P0	4.00 ± 0.10	4.00 ± 0.10
P	4.00 ± 0.10	4.00 ± 0.10
P1	2.00 ± 0.05	2.00 ± 0.05
D0	1.50 ± 0.10	1.50 ± 0.10
T	0.55 ± 0.20	0.55 ± 0.20

▲ Reel Dimensions

unit: mm



Series	M	W	A	B	C	D
LRNN	178.0 ± 2.0	$8.4 + 0.5/-0$	2.0 ± 0.5	13.2 ± 0.5	17.70 ± 0.5	60.0 ± 1.0

▲ Quantity of Package

Size	Quantity (pcs)
0612/0508	5,000

■ Reliability test item < Electrical Performance >

Item	Test condition/ Methods	Limited	Standard													
Temperature coefficient of resistance	TCR =(R-R ₀)/R ₀ (T ₂ -T ₁)X 10 ⁶ R ₀ : resistance of room temperature R: resistance of 125℃ ; T ₁ : Room temperature T ₂ : Temperature at 125℃	Refer to Spec	MIL-STD-202 Method 304													
Short time Overload	Applied Overload for 5 seconds , then measure its resistance variance rate. (Test condition refer to below)	≤±1.0%	IEC60115-1 4.13													
	<table><tr><th>Type</th><th>Resistance(mΩ)</th><th>Power rating</th></tr><tr><td rowspan="2">0612</td><td>1≤R≤10</td><td>4 times</td></tr><tr><td>10 < R≤25</td><td>3 times</td></tr><tr><td rowspan="2">0508</td><td>1≤R≤10</td><td>3 times</td></tr><tr><td>9≤R≤10</td><td>3 times</td></tr></table>			Type	Resistance(mΩ)	Power rating	0612	1≤R≤10	4 times	10 < R≤25	3 times	0508	1≤R≤10	3 times	9≤R≤10	3 times
	Type			Resistance(mΩ)	Power rating											
	0612			1≤R≤10	4 times											
				10 < R≤25	3 times											
	0508			1≤R≤10	3 times											
9≤R≤10		3 times														
Resistance to Soldering Heat	260℃± 5℃ time: 10sec±1sec	≤±0.5%	MIL-STD-202 Method 210													
Solderability	Temperature of Solder: 245±5℃ Dipping time:3±1s	Solder coverage over 95%	IEC60115-1 4.17													
Temperature Cycling	-55℃ (15min)/+150℃(15min), 300 cycles	≤±1.0%	MIL-STD-202													
Low temperature Storage	-55±2℃ for 96hours, No power	≤±1.0%	IEC60115-1 4.23.4													
High Temperature Storage	150℃ for 1000hours, No power	≤±1.0%	IEC60115-1 4.25													
Bias Humidity	85℃/85% RH, 10% Rated power, 1000hours	0612: 1.5~10mR, ΔR≤±1% 11~20mR, ΔR≤±2% 0508: 1~8mR, ΔR≤±1% 9~10mR, ΔR≤±2%	MIL-STD-202													
Vibration	The frequency varies from 10HZ to 55HZ and return to 10HZ, shall be transferred in 1 min. Amplitude : 1.5mm, 3 directions, and 12 hours	≤±0.5%	MIL-STD-202													
Operational life	70℃± 2℃, 1000 hours, at rated power 1.5 hours “ON”, 0.5 hours “OFF”	0612: 1.5~9mR, ΔR≤±1% 10~20mR, ΔR≤±3% 0508: 1~8mR, ΔR≤±1% 9~10mR, ΔR≤±3%	MIL-STD-202 Method 108													
Moisture resistance	MIL-STD-202,method106, No power, 7b not required	≤±0.5%	MIL-STD-202													

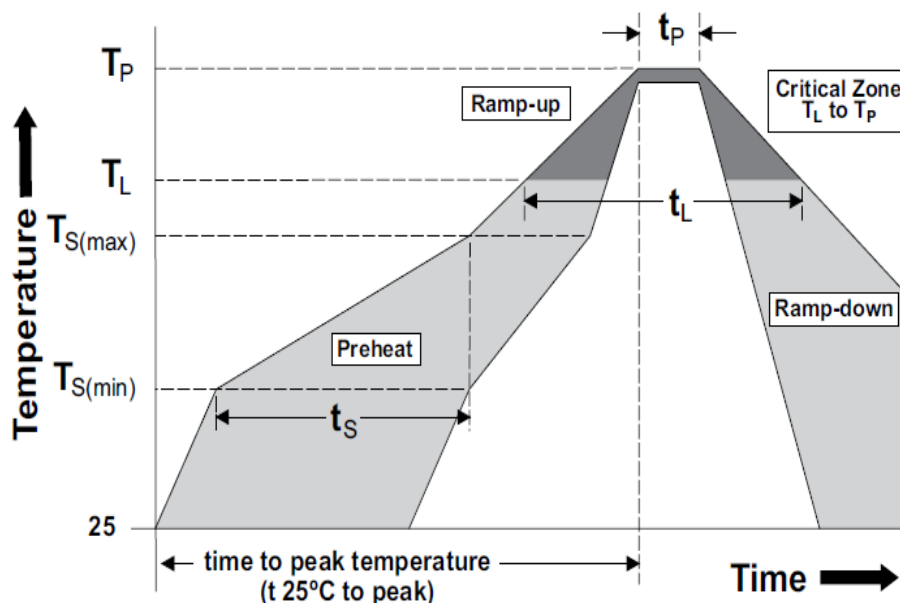
Note : Measurement at 24±4 hours after test conclusion for all reliability tests-parts.

Recommend Soldering Method:

This is for recommendation, please customer perform adjustment according to actual application

*Recommend solder paste: 96.5Sn/3.0Ag/0.5Cu

IR Reflow-Soldering Profile



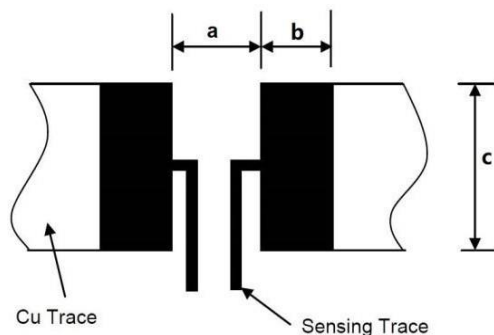
Reflow Condition		Pb – Free assembly
Pre heat	- Temperature Min ($T_s(min)$)	150°C
	- Temperature Max ($T_s(max)$)	200°C
	- Time (Min to Max) (t_s)	60 – 120 secs
Average ramp up rate (Liquidus Temp (T_L) to peak)		5°C/second max
Reflow	$T_s(max)$ to T_L - Ramp-up Rate	5°C/second max
	- Temperature (T_L) (Liquidus)	217°C
	- Time (t_L)	60 – 150 seconds
	Peak Temperature (T_P)	260°C
Time within 5°C of actual peak Temperature (t_p)		10 – 30 seconds
Ramp-down Rate		6°C/second max
Time 25°C to peak Temperature (T_P)		8 minutes Max.
Wave Soldering		260°C, 10 seconds max.
Hand Soldering		350°C, 5 seconds max.

Recommended IR Reflow Soldering Profile MEET J-STD-020D

Soldering Iron:

Temperature 350°C±10°C, dwell time shall be less than 3 sec.

Recommended Solder Pad Layout



Unit: mm

Size	a	b	c
0612	0.80	1.00	3.50
0508	0.50	0.90	2.30

Label



Storage requirement

*The temperature condition must be controlled at 5~35℃, the R.H. must be controlled at 40~75%. The stock can maintain quality level in two years.

**Please avoid the mentioned harsh environment below when storing to ensure product performance and its' weld ability. Places exposed to sea breeze or other corrosive gas, such as Cl₂, H₂S, NH₃, SO₂ and NO₂.

***When the product is moved and stored, please ensure the correct orientation of the box. Do not drop or squeeze the box. Otherwise, the electrode or the body of the product may be damaged.

Operation and Processing Precautions:

- ① Handle with care when printing circuit board (PCB) is divided or fixed on support body, because bending of printing circuit board (PCB) mounting will make mechanical stress for resistors.
- ② Make sure the power rating is under the limit when using the resistor. When power rating is over the limit, the resistor will be overloaded. There might be machinery damage due to the climbing temperature.
- ③ Avoid damage to the edge of resistor and protective layer caused by mechanical stress.

Notice

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文件修订履历表

文件名称	LRLN series Current sensing Resistor	编号	NQ-APS-042
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版本日期	版次	修订页次	修订内容		修定者	备注
			修订前	修订后		
2023/02/07	A0	/	/	新制发行	张树峰	